

## Features

- SOT-25 Low Cost Miniature Plastic Package
- 6.5 dB Typical Conversion Loss
- +3 to +7 dBm LO Drive
- HMIC™ Patented Process
- Silicon Low Barrier Schottky Barrier Diodes
- DC - 400 MHz IF Bandwidth
- RoHS\* Compliant with 260°C Reflow Capability
- 100 % Matte Tin Plating

## Description and Applications

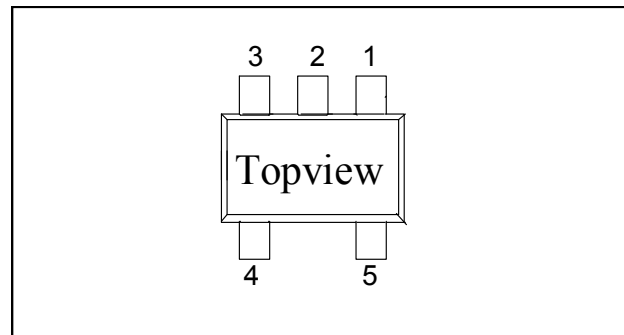
M/A-COM's MA4EX950L1-1225T is a 700-1200 MHz silicon monolithic double balanced mixer in a low cost miniature surface mount SOT-25 package. The die uses M/A-COM's unique HMIC silicon/glass process to realize low loss passive elements while retaining the advantages of medium barrier silicon Schottky barrier diodes.

These mixers are well suited for high volume wireless and cellular applications where small size and repeatability are required. Typical applications include frequency conversion, modulation, and demodulation in wireless receivers and transmitters.

## Ordering Information

Part Number	Package
MA4EX950L1-1225T	Tape and Reel

## SOT-25 Package Outline (Topview)



## PIN Configuration

PIN	Function	PIN	Function
1	RF	4	GND
2	GND	5	IF
3	LO	-	-

\* Restrictions on Hazardous Substances, European Union Directive 2005/95/EC.

## Silicon Double Balanced HMIC Mixer 700 - 1200 MHz

Rev. V3

### Electrical Specifications @ +25 °C

Parameter	Frequency Range	Test Conditions	Units	Min.	Typ.	Max.
Conversion Loss	850 MHz 0.7—1.2 GHz	LO Drive = +3 -> + 7dBm RF = -10 dBm, IF = 60 MHz	dB		7.0 8.0	7.5 10.5
L - R Isolation	850 MHz 0.7—1.2 GHz	LO Drive = +5 dBm RF Level = -10 dBm	dB		28.0 25.0	
L - I Isolation	850 MHz 0.7—1.2 GHz	LO Drive = +5 dBm RF Level = -10 dBm	dB		27.0 26.0	
R - I Isolation	850 MHz 0.7—1.2 GHz	LO Drive = +5 dBm RF Level = -10 dBm	dB		28.0 24.0	
LO VSWR	850 MHz 0.7—1.2 GHz	LO Drive = +5 dBm RF Level = -10 dBm			2.4:1 2.8:1	- -
RF VSWR	850 MHz 0.7—1.2 GHz	LO Drive = +15 dBm RF Level = -10 dBm			1.3:1 2.7:1	- -
IF VSWR	DC - 400 MHz	LO Drive = +5 dBm RF Level = -10 dBm			1.4:1	-
Input IP3	850 MHz 0.7—1.2 GHz	LO Drive = +3 -> + 7dBm RF = -10 dBm, IF = 60 MHz	dBm	11.0 9.0	13.2 14.0	
Input 1 dB Compression	850 MHz 0.7—1.2 GHz	LO Drive = +3 -> + 7dBm RF = -10 dBm, IF = 60 MHz	dBm		0 +1.5	
IF 1 dB Bandwidth	DC - 400 MHz	LO = 4650 MHz @ +5 dBm	MHz	0		400.0

# MA4EX950L1-1225T

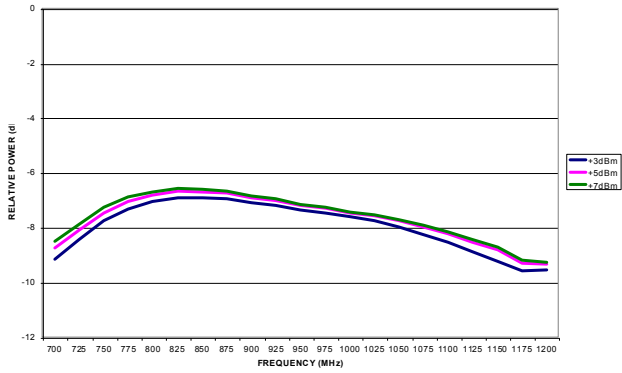


**Silicon Double Balanced HMIC Mixer**  
**700 - 1200 MHz**

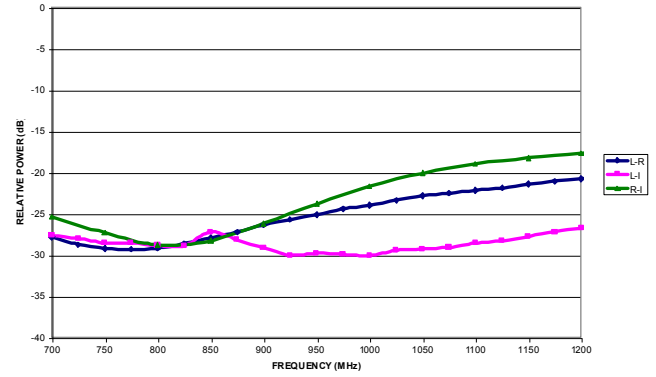
Rev. V3

**Typical Performance Curves (LO Drive = +10 dBm, RF = -10 dBm, IF = 60 MHz)**

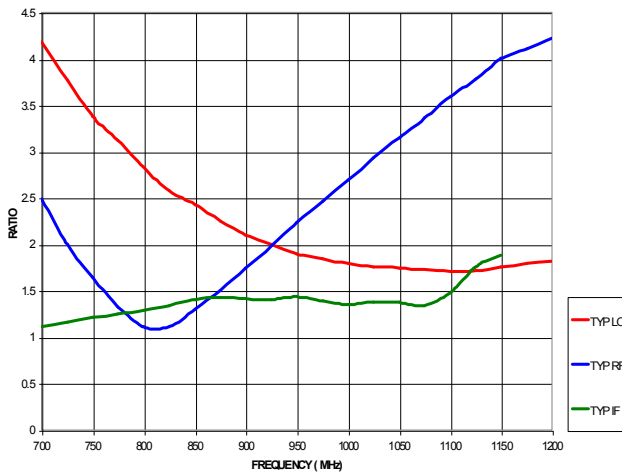
**Conversion Loss**



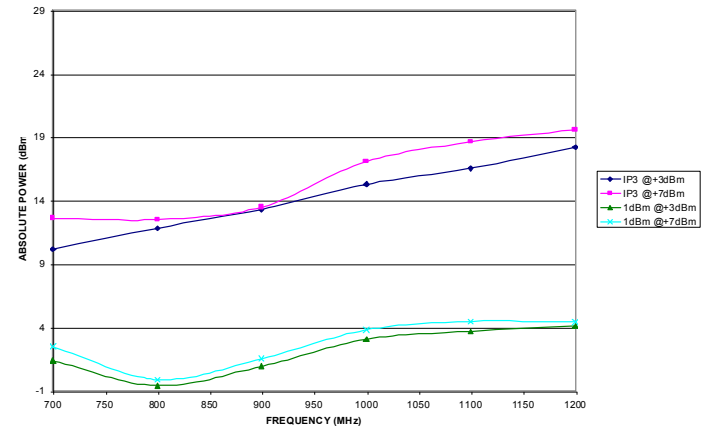
**Isolation**



**Typical LO, RF and IF VSWR**



**Third Order Intercept and Input 1 dB Compression Power**



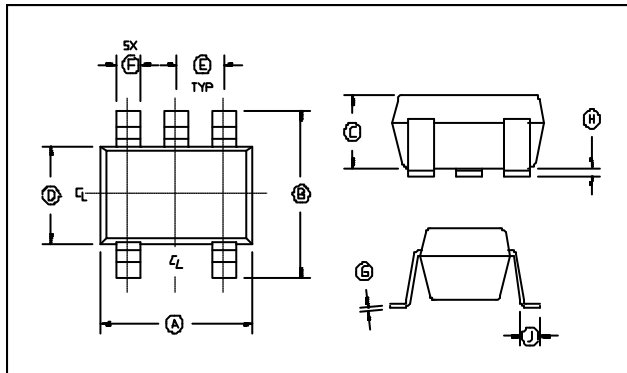
# MA4EX950L1-1225T



**Silicon Double Balanced HMIC Mixer**  
700 - 1200 MHz

Rev. V3

## Case Style SOT-25



## SOT-25<sup>3,4</sup>

Dim	Inches		Millimeters	
	Min.	Max.	Min.	Max.
A	.1103	.1181	2.80	3.10
B	.1023	.1181	2.6	3.00
C	0.0355	.0512	0.9	1.30
D	0.0591	0.669	1.5	1.70
E	.0374 REF.		.095 REF.	
F	.0138	.0197	.35	.50
G	.0031	0.0079	.08	0.2
H	.0002	.0059	.05	.15
J	0.138	0.216	.35	.55

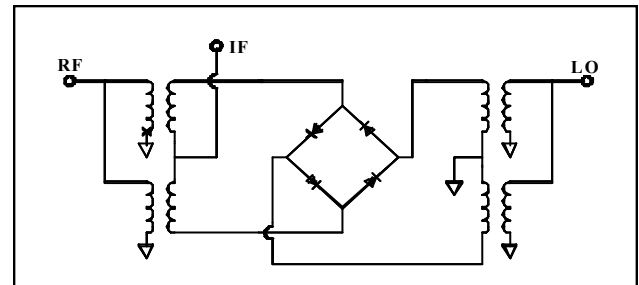
## Absolute Maximum Ratings<sup>1,2</sup>

Parameter	Maximum Ratings
Operating Temperature	-65 °C to +125 °C
Storage Temperature	-65 °C to +150 °C
Incident LO Power	+20 dBm
Incident RF Power	+20 dBm
Mounting Temperature	+235 °C for 10 seconds
Soldering Temperature	+260 °C max.

1. Exceeding these limits may cause permanent damage.
2. Please refer to application note M538 for surface mounting instructions.

3. Dimensions do not include mold flash, protrusion or gate burrs which shall not exceed 0.0098 in (.25mm) per side.
4. Lead Coplanarity is 0.003 (0.08) max.

## Schematic



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